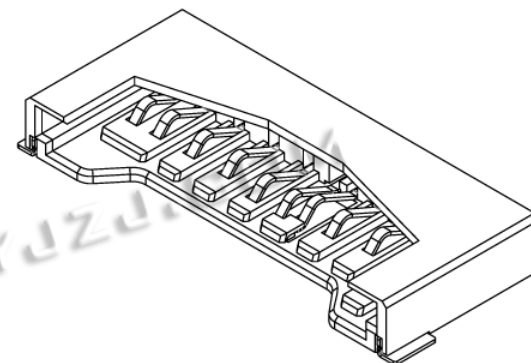
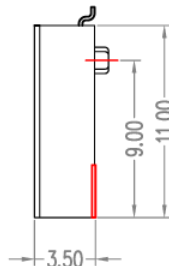
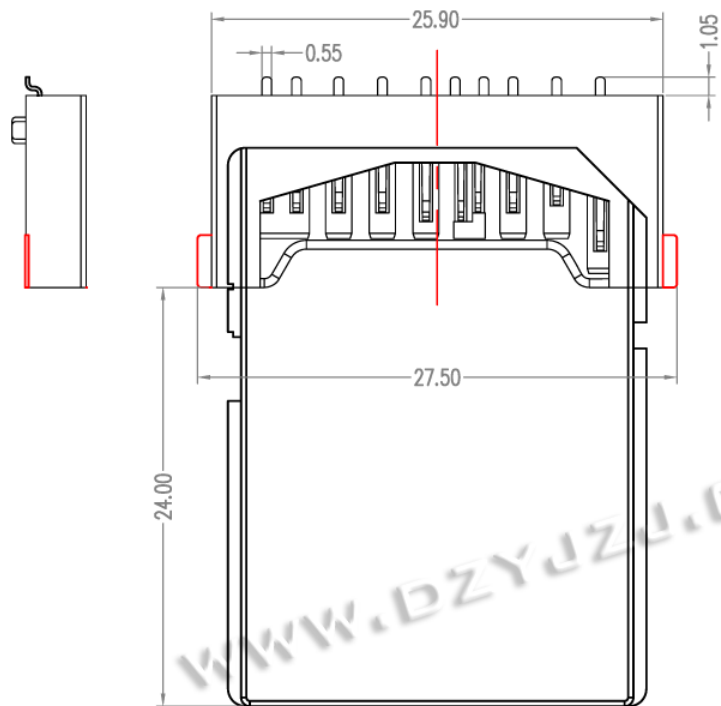
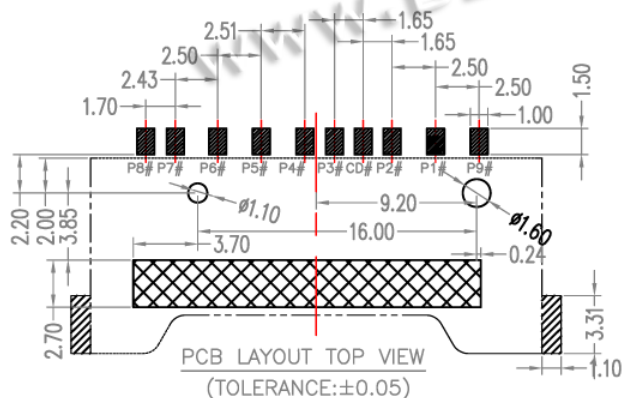




3D VIEW

SD CARD PIN DESIGN			
Pin#	Name	Type	Card Detect/ Data Line[3:1]
1	CD/DAT3	I/O/PP	Command/Response
2	CMD	PP	Supply voltage
3	Vss1	S	Supply voltage ground
4	VDD	S	Supply voltage
5	CLK	I	Clock
6	Vss2	S	Supply voltage ground
7	DAT0	I/O/PP	Date Line [Bit0]
8	DAT1	I/O/PP	Date Line [Bit1]
9	DAT2	I/O/PP	Date Line [Bit2]



 Pad Area

 Keep Out Area

SPECIFICATION

1.ELECTRICAL CHARACTERISTICS:

CONTACT CURRENT RATING:0.5 AMPERES.
DIELECTRIC WITHSTANDING VOLTAGE:AC500VR.M.S.
INSULATION RESISTANCE:1000M Ω MINIMUM,
CONTACT RESISTANCE:40M Ω MAXIMUM.

2. ENVIRONMENTAL:

OPERATING TEMPERATURE: -20 °C ~ +85 °C.

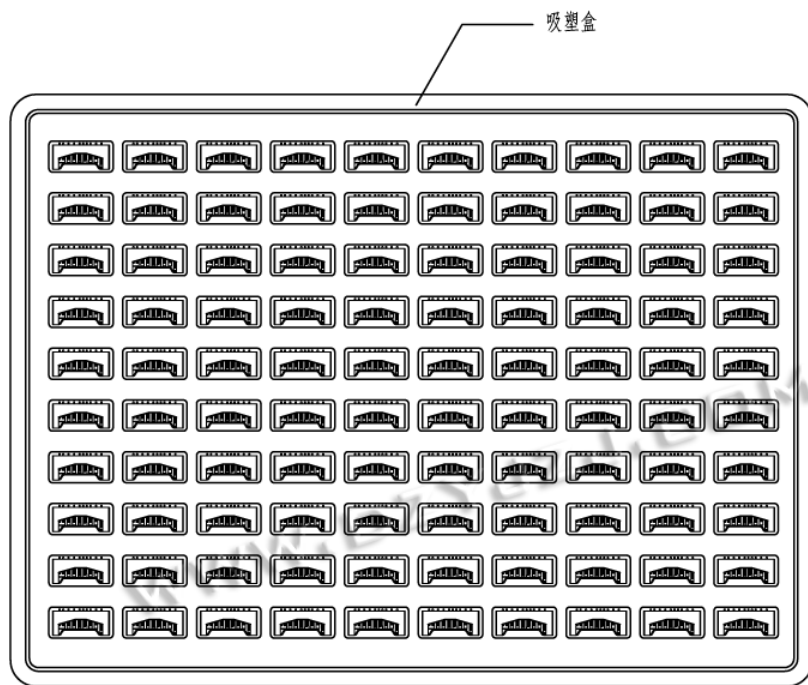
3. MATERIALS

HOUSING: H1-TEMP PLASTIC LCP UL 94V-0 RATED
CONTACT: COPPER ALLOY (T=0.20MM).

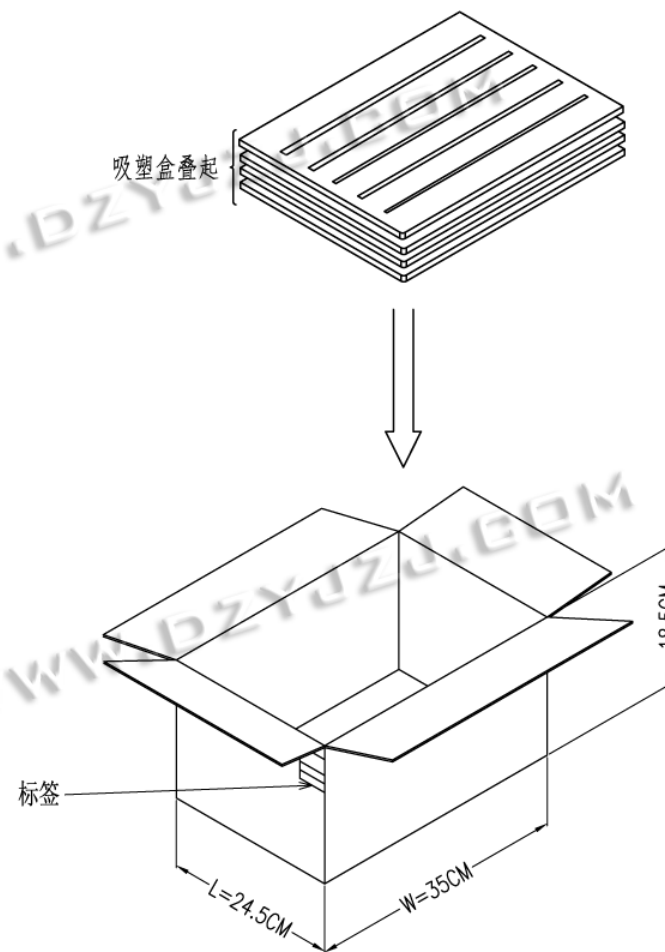


深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*				SD简易全塑（带焊脚）	
		CHECKED BY:	DATE :	PART NO.	HYC32-SD11-275
		马跃	2014-02-23	MOLD NO.	
UNIT: mm [inch]		APPROVED BY:	DATE :	DRAW NO:	HYC-SD15081918
SCALE:1:1	SIZE: A4	邱国夷	2014-02-23	SHEET NO.	1 OF 1



Packaging to Box



1. 材质要求:

1.1 纸箱材质:A=B; 尺寸:35*24.5*18.5CM;

2. 包装要求:

2.1 将装好产品的吸塑盒重叠叠起, 每叠30盘分别用PE膜缠绕好捆成一捆, 按统一方向放入纸箱, 并在纸箱内放置干燥剂

2.2 把包装好的成品用胶纸打包封箱, 并在纸箱外贴上标签

3. 包装数量: 30盘 x 100PCS/盘 = 3000 PCS/箱



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	
			SHEET NO.	1 OF 1